Digital Transmitter Coil for Wireless Power Transfer Robust Against Variation of Distance and Lateral Misalignment

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Abstract—A digital transmitter (TX) coil consisting of several subcoils connected in parallel is proposed in wireless power transfer (WPT) systems robust against the variation of distance and lateral misalignment. According to the position of the receiver coil, the radius of the digital TX coil can be programmed to its optimal value to achieve the maximum coil-to-coil efficiency. Moreover, targeting the wireless charging of mobile devices, we propose a practical design methodology for the digital TX coil. It is concluded that the digital TX coil consisting of two subcoils is an effective design and that the performance is not significantly improved by adding more subcoils. The optimal radius ratio of these two subcoils is 0.54. Furthermore, we implement the designed digital TX coil in a prototype WPT system, including a power amplifier and a rectifier. Experimental results show that within a space with a maximum distance and lateral misalignment of 100 mm, the system efficiency is improved by the digital TX coil and reaches a maximum value of 48%. Compared with using a conventional TX coil with a constant radius, the system efficiency shows an absolute improvement of up to 7%.

Index Terms—Coil design methodology, coil-to-coil efficiency, distance, lateral misalignment, magnetic resonance coupling, mutual inductance, optimal radius, wireless power transfer (WPT).

I. INTRODUCTION

WIRELESS power transfer (WPT) based on magnetic resonance coupling has been applied in a wide range of applications, such as mobile devices and biomedical implanted devices [1]–[3]. The variation of the distance and lateral misalignment of the receiver (RX) coil relative to the transmitter (TX) coil, however, strongly affects the WPT system efficiency ($\eta_{SYS}$) and is a critical problem. The discussion of angular misalignment is out of the scope of this article. During the wireless charging of mobile devices, it is preferable that devices are not placed on a wireless charging pad but can be held in hand and operated. Therefore, a method robust against the variation of distance and lateral misalignment is required for WPT systems.

The previously reported methods are mainly divided into three categories [1]: control methods [4]–[11], circuit compensation topologies [12]–[14], and coil design [15]–[18]. In the first category, frequency tracking [4]–[6], impedance matching networks [7], [8], and coil repeaters [9]–[11] have been proposed to achieve impedance matching between the TX coil input impedance and the source impedance over a wide range. In the second category, in addition to the traditional compensation topologies (series–series, series–parallel, parallel–series, and parallel–parallel), several new topologies, such as capacitor–capacitor–inductor [12], inductor–capacitor–capacitor [13], and hybrid topologies [14], with better misalignment performance have been proposed. However, in the above-mentioned two categories, the complex circuit topology makes the system more sensitive to parameter variations [19], affecting its reliability. In addition, coil-to-coil efficiency ($\eta$) cannot be improved.

On the other hand, in the third category, the coil design can directly maximize $\eta$, and thus, maximize $\eta_{SYS}$. From the practical viewpoint, the TX coil design is preferable to the RX coil design. In [15], the pattern of the TX coil was designed to realize a relatively uniform magnetic field distribution under lateral misalignment. However, its tolerance to the variation of distance is not demonstrated. In [16], the optimal TX coil layout design with respect to the distance was proposed, but it was not discussed how to change its layout adaptively. Volumetric coil structures [17], [18] have been proposed to minimize the effects of variation of distance and lateral misalignment but are not easily implementable in practice.

Our major contributions in this article are summarized as follows: 1) we propose a digital TX coil topology, which consists of several subcoils connected in parallel where the coil radius can be programmed to its optimal value giving the maximum $\eta$. 2) We propose a practical design methodology for the digital TX coil, including the number of subcoils and their radii, under the variation of distance and lateral misalignment. 3) We implement the digital TX coil in a prototype and demonstrate its effectiveness in a WPT system robust against the variation of distance and lateral misalignment. Compared with our earlier work [20], we have added a discussion about lateral alignment, proposed a practical design methodology, and implemented the digital TX coil in a prototype WPT system.

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Fig. 1. (a) Configuration of the TX and RX coils. A single turn of TX and RX coils is shown for simplicity. (b) $r_{TX}$ dependence of $\eta$. (c) Position dependence of $\eta$ using the conventional TX coil with constant $r_{TX}$ and the proposed TX coil with programmable $r_{TX}$.

The rest of this article is organized as follows. In Section II, the optimal radius of the TX coil giving the maximum $\eta$ is discussed. Then, the digital TX coil topology is proposed in Section III. A practical design methodology for the digital TX coil under the variation of distance and lateral misalignment is proposed in Section IV. Experimental results are presented in Section V. Finally, conclusions are given in Section VI.

II. OPTIMAL TRANSMITTER COIL RADIUS FOR MAXIMUM EFFICIENCY UNDER THE VARIATION OF DISTANCE AND LATERAL MISALIGNMENT

Fig. 1 shows the key concept of this article. The configuration of the TX and RX coils is shown in Fig. 1(a). The radii of the TX and RX coils are denoted by $r_{TX}$ and $r_{RX}$, respectively. In this article, the axes of the coils are always parallel. Distance and lateral misalignment are denoted by $z$ and $x$, respectively. As shown in Fig. 1(b), $\eta$ shows a peak when $r_{TX}$ approaches its optimized value ($r_{TX,OPT}$) and a smaller or larger $r_{TX}$ will degrade $\eta$ [20], [21]. In our WPT system design, we first optimize the TX coil to maximize $\eta$ at the farthest position ($x$, $z$). When the RX coil moves nearer to ($x'$, $z'$), with a constant $r_{TX}$ in the conventional (CON) design, $\eta$ increases to $\eta_{CON}$ owing to the enhanced coupling. On the other hand, if a TX coil with an adjustable $r_{TX}$ is used in the proposed (PPSD) design, $\eta_{CON}$ can be further improved to $\eta_{PPSD}$. Thus, compared with the conventional design, the proposed design can achieve better misalignment tolerance. In this section, we derive the relationship between $r_{TX,OPT}$ and ($x$, $z$).

A. Equivalent Circuit Analysis

Fig. 2 shows the equivalent circuit of a WPT system. The TX side consists of a voltage source ($V_S$) with an internal resistance ($R_S$), an inductor ($L_{TX}$) with a parasitic resistance ($R_{TX}$), and a compensation capacitor ($C_{TX}$). The RX side is composed of an inductor ($L_{RX}$) with a parasitic resistance ($R_{RX}$), a compensation capacitor ($C_{RX}$), and a load resistance ($R_L$). The currents flowing in the TX and RX sides are $I_{TX}$ and $I_{RX}$, respectively. $k$ is the coupling coefficient between the TX and RX coils. Applying Kirchhoff’s voltage law to the circuit, we obtain the following equations at the resonance frequency ($f_0$):

$$\omega_0 = 2\pi f_0$$
$$M = k\sqrt{L_{TX}L_{RX}}$$
$$V_S = I_{TX}[R_T + L_{TX} + j\omega_0 L_{TX} + 1/(j\omega_0 C_{TX})]$$
$$- j\omega_0 M I_{TX} L_{RX}$$
$$j\omega_0 M I_{TX} = I_{RX}[R_L + R_{RX} + j\omega_0 L_{RX} + 1/(j\omega_0 C_{TX})]$$
$$L_{TX}C_{TX} = L_{RX}C_{RX} = (\omega_0)^{-2}$$

where $M$ is the mutual inductance between the TX and RX coils, $\omega_0$ is the resonant angular frequency, and $j$ is the imaginary unit.

$\eta$ is defined by the ratio of the power output from the RX coil to the power input into the TX coil [22]. In addition, when $R_L$ is assumed to equal its optimal value ($R_{L,OPT}$) of $R_{RX}(1 + k^2 Q_{TX} Q_{RX})^{1/2}$, $\eta$ can be expressed as

$$\eta = \frac{k^2 Q_{TX} Q_{RX}}{(1 + \sqrt{1 + k^2 Q_{TX} Q_{RX}})^2}$$

where

$$k^2 Q_{TX} Q_{RX} = \frac{(\omega_0 M)^2}{R_{TX} R_{RX}}.$$

Here, $Q_{TX}$ and $Q_{RX}$ are the quality factors of the TX and RX coils, respectively. Thus, $\eta$ can be maximized by maximizing $k^2 Q_{TX} Q_{RX}$.

B. Derivation of Optimal Transmitter Coil Radius

$k^2 Q_{TX} Q_{RX}$, on the other hand, is correlated with the physical parameters of the coils. First, we discuss the calculation of the coil resistances. For a tightly wound coil, the resistance depends on both the skin effect and the proximity effect and can be expressed as follows [23]:

$$R_{TX} = \frac{2\pi r_{TX}}{\sigma} \left(1 + \frac{\sigma r}{\delta} + \frac{3\delta}{4\sigma}\right)(1 + G_P)$$

$$R_{RX} = \frac{2\pi r_{RX}}{\sigma} \left(1 + \frac{\sigma r}{\delta} + \frac{3\delta}{4\sigma}\right)(1 + G_P).$$

Here, $\sigma$ is the conductivity of copper ($5.96 \times 10^7$ S/m), and $\sigma r$ is the diameter of the copper wire (1 mm). $m$ and $n$ are...
the numbers of turns of the TX and RX coils, respectively. The skin depth (δ) is calculated as \((\pi \mu_0 f_0 \sigma)^{-1/2}\), where \(\mu_0\) is the vacuum permeability \((4\pi \times 10^{-7} \text{ H/m})\). The proximity effect is included in the proximity factor \((G_p)\) [24].

Second, employing Neumann’s equation [25], \(M\) can be determined by adding all combinations of \(M_{pq}\) between the \(p\) loop of the TX coil and the \(q\) loop of the RX coil

\[
M = \sum_{p=1}^{m} \sum_{q=1}^{n} M_{pq}
\]

and

\[
M_{pq} = \frac{\mu_0}{\pi} \sqrt{r_{TX}r_{RX}} \int_{0}^{\pi} \left(1 - \frac{x}{r_{RX}} \cos \phi\right) \Phi(\beta) \, d\phi \tag{6}
\]

where

\[
U = \sqrt{1 + \frac{x^2}{r_{RX}^2} - 2 \frac{x}{r_{RX}} \cos \phi} \tag{7}
\]

\[
\Phi(\beta) = \left(\frac{2}{\beta} - \beta\right) K(\beta) - \frac{2}{\kappa} E(\beta) \tag{8}
\]

\[
\beta = \frac{4 \pi r_{TX} r_{RX} U}{(r_{RX} + r_{TX} U)^2 + \frac{z_{pq}}{2}} \tag{9}
\]

\[
z_{pq} = z + \frac{p - 1}{m} r_{TX} + \frac{q - 1}{n} r_{RX}. \tag{10}
\]

Here, \(\phi\) is the angle in the integration, and \(K\) and \(E\) are the first kind and the second kind of complete elliptic integrals, respectively [26]. \(r_{TX}\) and \(r_{RX}\) are the thicknesses of the TX and RX coils, respectively. \(z_{pq}\) denotes the distance of the \(q\) loop of the RX coil relative to the \(p\) loop of the TX coil, and \(z\) is defined as \(z_{pq}\) when \(p = q = 1\).

Thus, by substituting (4)–(6) into (3), \(k^2 Q_{TX} Q_{RX}\) can be obtained. It is found that when \(f_0, m, n,\) and \(r_{RX}\) are constants, for a specific \((x, z)\), \(k^2 Q_{TX} Q_{RX}\) reaches its maximum when \(r_{TX}\) equals \(r_{TX,OPT}\), which is obtained by solving

\[
\frac{\partial}{\partial r_{TX}} k^2 Q_{TX} Q_{RX} = 0. \tag{11}
\]

In this article, we consider our target application as wireless charging of mobile devices and select \(f_0\) as 150 kHz. The maximum \(z\) (\(z_{\text{max}}\)) and maximum \(x\) (\(x_{\text{max}}\)) are both set as 100 mm. Fig. 3(a) shows the calculated dependence of \(r_{TX,OPT}\) on \((x, z)\) obtained from (11) using \(r_{RX} = 100\) mm, \(m = n = 10\), and \(r_{TX} = r_{RX} = 13\) mm. Starting from \(r_{TX,OPT} = 100\) mm at \((0\) mm, \(0\) mm), \(r_{TX,OPT}\) increases with increasing misalignment and reaches 205 mm at \((100\) mm, \(100\) mm). Fig. 3(b) shows the coil configurations at four selected positions (A, B, C, and D). Compared with the distance dependence, \(r_{TX,OPT}\) is affected more strongly by lateral misalignment.

III. PROPOSED DIGITAL TRANSMITTER COIL TOPOLOGY

To implement the TX coil with a programmable \(r_{TX}\) according to different positions of the RX coil, a digital TX coil topology is proposed. Fig. 4 shows a schematic of the WPT system. The TX side consists of a power amplifier (PA), the proposed digital TX coil, and a switch (SW) control unit. The digital TX coil consists of \(N\) concentric subcoils connected in parallel. The \(l\) coil (TX\(_l\)) with a radius of \(r_{TX,l}\) is connected with the corresponding compensation capacitance (C\(_l\)) and SW (SW\(_l\)) in series, where \(l = 1, 2, \ldots, N\). The RX side consists of the RX coil, a rectifier followed by a smoothing capacitor (C\(_L\)), and R\(_L\). For each specific position...
of the RX coil, one of the subcoils is turned on. Thus, the radius of the digital TX coil can be adjusted to the corresponding $r_{TX,OPT}$ electronically rather than mechanically, such as by using motors. In addition, a LabVIEW program is developed to support the automatic operation of the SW control unit. Details are given in Section V-A.

Fig. 5 shows the equivalent circuit. The $l$ subcoil in the digital TX coil is denoted by an inductance ($L_l$) and a parasitic resistance ($R_l$) connected in series. $f_0$ for each subcoil in the digital TX coil is the same as that of the RX coil. The rectifier consists of four diodes, $D_1$–$D_4$. The dc voltage supply is $V_{DD}$, and the dc current flowing into the PA is $I_D$. The input voltage and current of the digital TX coil are denoted by $V_{IN}$ and $I_{IN}$, respectively. The output voltage and current of the RX coil are denoted by $V_{OUT}$ and $I_{OUT}$, respectively. The voltage across $R_L$ is denoted by $V_{Load}$.

IV. DESIGN METHODOLOGY OF DIGITAL TRANSMITTER COIL UNDER THE VARIATION OF DISTANCE AND LATERAL MISALIGNMENT

Using the proposed digital TX coil with adjustable $r_{TX}$, we can obtain the maximum $\eta$ at each position. However, it would be impractical to implement the digital TX coil with an infinite number of subcoils, considering that in the application scenario, the RX coil can move continuously within the wireless charging space. Thus, in this section, we propose a practical design methodology that determines the number of subcoils in the digital TX coil and their radii ($r_{TX1,OPT}$, $r_{TX2,OPT}$, ..., $r_{TXN,OPT}$) under the variation of distance and lateral misalignment.

A. Performance Indicator

First, we define the average $\eta$ ($\bar{\eta}$) as the key performance indicator

$$\bar{\eta} = \frac{\int_{x \max}^{0} \int_{z \max}^{0} \eta dz dx}{x \max z \max}. \quad (12)$$

A higher $\bar{\eta}$ indicates a better performance.

B. Design Methodology of Digital Transmitter Coil

In this part, we calculate and compare $\bar{\eta}$ values for different $N$. As discussed at the beginning of Section II, we first maximize $\eta$ at $(x_{\max}, z_{\max})$ and set $r_{TX1}$ as 205 mm in accordance with position D in Fig. 3(b).
Fig. 8. Calculated η surfaces using (a) TX1, (b) TX2, and (c) digital TX coil for N = 2 under different misalignment conditions.

rTX2,OPT equal 205 and 110 mm, respectively, and $\eta_{\text{max}}$ is greater than that for N = 1.

To demonstrate how $\bar{\eta}_{\text{max}}$ increases from N = 1 to N = 2, Fig. 8 shows a comparison of η surfaces using TX1 with $r_{\text{TX1,OPT}}$, TX2 with $r_{\text{TX2,OPT}}$, and the digital TX coil for N = 2. TX1 and TX2 perform well far from and near (0 mm, 0 mm), respectively. Thus, as shown in Fig. 8(c), with TX1 and TX2 turned on outside and inside the highlighted black volume, respectively, the digital TX coil achieves a higher η than TX1 in Fig. 8(a). The boundary on the η surface is defined by $\eta(r_{\text{TX}} = r_{\text{TX1,OPT}}) = \eta(r_{\text{TX}} = r_{\text{TX2,OPT}})$.

After obtaining $\eta_{\text{max}}$ for N = 1 and 2, the results for N = 3–6 are calculated and are shown in Fig. 9(a). It is found that $\eta_{\text{max}}$ is improved greatly by using two subcoils but increases slightly when N exceeds two. This means that the digital TX coil consisting of two subcoils is a practical design, and adding any more subcoils only increases the system’s cost without significantly improving its performance. Fig. 9(b) shows the ratio of $r_{\text{TXl,OPT}}$ (l = 1, 2, ..., N) to $r_{\text{TX1,OPT}}$ for different N. In the optimized design (N = 2), the ratio of $r_{\text{TX2,OPT}}$ to $r_{\text{TX1,OPT}}$ is 0.54.

When using the digital TX coil with the optimized design, $\bar{\eta}_{\text{max}}$ is 91%, compared with 87% obtained using the conventional TX design, that is, N = 1. In this article, the coil parameters are selected to obtain high-quality factors, and the possible improvement of the performance is limited. Thus, in real applications where the coil quality factors are usually lower, the advantage of using the proposed digital TX coil over the conventional TX coil will be greater.

C. Scalability of Proposed Design Methodology

In addition, the scalability of the proposed design methodology is discussed. It has been demonstrated that the ratio of the distance to the coil radius determines η in a WPT system [27], [28]. Then, it can be predicted that, under the variation of distance and lateral misalignment, η is determined by the ratios of the distance and lateral misalignment with the coil radius. Thus, if the WPT system is scaled up or down with constant ratios of $x_{\text{max}}/r_{\text{RX}}$ and $z_{\text{max}}/r_{\text{RX}}$, the same results as in Fig. 9 can be obtained (data not shown). This indicates that
Fig. 10. Photograph of the digital TX coil consisting of TX1 and TX2 with the optimized design and the RX coil.

TABLE I

<table>
<thead>
<tr>
<th>DIGITAL TRANSMITTER COIL</th>
<th>RECEIVER COIL</th>
</tr>
</thead>
<tbody>
<tr>
<td>Parameter</td>
<td>Value</td>
</tr>
<tr>
<td>$r_{TX1}$</td>
<td>205 mm</td>
</tr>
<tr>
<td>$r_{TX2}$</td>
<td>13 mm</td>
</tr>
<tr>
<td>$m_1$</td>
<td>10</td>
</tr>
<tr>
<td>$f_s$</td>
<td>150 kHz</td>
</tr>
<tr>
<td>$I_{L1}$</td>
<td>110 μH</td>
</tr>
<tr>
<td>$C_1$</td>
<td>10.2 nF</td>
</tr>
<tr>
<td>$R_D$</td>
<td>0.80 Ω</td>
</tr>
<tr>
<td>$Q_1$</td>
<td>129</td>
</tr>
<tr>
<td>$r_{TX2}$</td>
<td>110 mm</td>
</tr>
<tr>
<td>$r_{TX2}$</td>
<td>13 mm</td>
</tr>
</tbody>
</table>

$r_{TX1}$ and $r_{TX2}$ are the thicknesses of TX1 and TX2, respectively. $m_1$ and $m_2$ are the numbers of turns of TX1 and TX2, respectively.

Table I shows their physical dimensions and electrical parameters measured using a network analyzer (Keysight E5061B). Relays (Panasonic TQ2-L2-4.5) with an on-resistance of less than 50 mΩ are used as the SWs.

As is shown in Fig. 11, a signal generator (Tektronix AFG3252) is used to generate a square wave signal at 150 kHz to drive a class-D PA (EPC 9511) [29]. The power of the class-D PA is supplied by TAKASAGO ZX-S-400LAN and KIKUSUI PMP16-1QU. The PA supplies the power to the digital TX coil, which is then wirelessly transferred to the RX coil. The four diodes in the rectifier use a DSEP60-12A Schottky diode from IXYS Corporation, Milpitas, CA, USA, $C_L$ and $R_L$ are an FG22 × 7.1H685KRT06 capacitor (6.8 μF) from TDK Corporation, Tokyo, Japan, and a PF2205-10RF1 resistor (10 Ω) from Riedon Resistors, Inc., Alhambra, CA, USA, respectively. For each position of the RX coil, SW1 and SW2 are turned ON one by one, and the corresponding $V_{DD}$, $I_D$, $V_{IN}$, $I_{IN}$, $V_{OUT}$, $I_{OUT}$, and $V_{Load}$ (shown in Fig. 5) are monitored using voltage probes (Tektronix P6139B) and current probes (Tektronix P6021A). The results are shown on oscilloscopes (Agilent D5054A and Tektronix TDS3054C).

$\eta$ is defined as the power delivered to $R_L$ divided by the dc power supply and is expressed as

$$\eta_{SYS} = \frac{V_{Load}^2}{V_{DD}^2} \times \frac{R_L}{I_D}$$

where the digital control power in the class-D PA is also included.

A LabVIEW control program is then run on a computer to process the information and generate the control voltages for SW1 and SW2 through a digital waveform generator (National Instruments PXIe-6555). $\eta_{SYS}$ is selected as the criterion for subcoil selection. If $\eta_{SYS}$ using TX1 is higher than that using TX2, SW1 is turned ON. Otherwise, SW2 is turned ON. Another possible criterion is $\eta$, which would make the implementation more feasible. By measuring $V_{IN}$ and $I_{IN}$, $V_{OUT}$, and $I_{OUT}$, we can calculate $\eta$. $\eta_{SYS}$ is defined as the power delivered to $R_L$ divided by the dc power supply and is expressed as

$$\eta_{SYS} = \frac{V_{Load}^2}{V_{DD}^2} \times \frac{R_L}{I_D}$$

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systems [5], [7], [11]. Thus, a simple switch control is realized. These two criteria will be compared in Section V-C.

B. Measurement and Comparison of Mutual Inductance

To confirm the accuracy of the calculation results, $M$ is measured in 2-D along the $x$- and $z$-directions every 20 mm from 0 to 100 mm using the method described in [22].

Fig. 12(a) shows the measured $M$ ($M_{\text{meas}}$) between TX$_1$ and the RX coil. Starting from 10.6 $\mu$H at (0 mm, 0 mm), $M_{\text{meas}}$ drops to 6.64 $\mu$H at (0 mm, 100 mm), which is a 37% reduction. On the other hand, it rises to 14.2 $\mu$H at (100 mm, 0 mm), a 33% increase, which is ascribed to the asymmetrical radii between TX$_1$ and the RX coil [21]. When the position of the RX coil is changed to (100 mm, 100 mm) with the largest misalignment, $M_{\text{meas}}$ drops to 5.98 $\mu$H, which is a 44% reduction. Fig. 12(b) shows $M_{\text{meas}}$ between TX$_2$ and the RX coil. $M_{\text{meas}}$ shows a maximum of 23.6 $\mu$H at (0 mm, 0 mm) and reductions of 80%, 71%, and 89% at (0 mm, 100 mm), (100 mm, 0 mm), and (100 mm, 100 mm), respectively.

Fig. 13(a) and (b) shows a comparison of $M_{\text{meas}}$ and the calculated $M$ ($M_{\text{cal}}$). The error is defined as $(M_{\text{meas}} - M_{\text{cal}})/M_{\text{meas}}$ and shows different trends for TX$_1$ and TX$_2$. It is small for TX$_1$ but large for TX$_2$ when the RX coil is near (0 mm, 0 mm). However, in both cases, the error is less than 10% over the entire region, which demonstrates the accuracy of (6) in calculating $M$. In addition, compared with the measurement results, the calculated $R_{TX}$ and $R_{RX}$ using (4) and (5) also show an error within 10% (data not shown). All these results verify the accuracy of the calculation results and validate the proposed design methodology of the digital TX coil.

C. System Efficiency Measurement of WPT Prototype

To evaluate the performance of the WPT prototype, starting from (0 mm, 0 mm), $\eta_{\text{SYS}}$ is measured point by point in 2-D along the $x$- and $z$-directions every 20 mm from 0 to 100 mm. At each position, the power supply of the class-D PA is modulated to regulate the power delivered to $R_L$ to 0.9 W.
Depending on which coil achieves the higher $η_{SYS}$, TX$_1$ or TX$_2$ in the digital TX coil is turned ON automatically, as described in Section V-A. In the measured distribution map shown in Fig. 14, the boundary indicated by the blue solid line distinguishes the regions where TX$_1$ or TX$_2$ is turned ON. When the RX coil is near (0 mm, 0 mm), TX$_2$ is turned ON. Otherwise, TX$_1$ is turned ON.

In addition, the distribution map using $η$ rather than $η_{SYS}$ as the criterion is shown for comparison in Fig. 14. The boundary is indicated by the red dashed line. This line coincides with the blue solid line except at two positions. Take the black arrow as an example. The switching from TX$_2$ to TX$_1$ increases $η$. From a systematic viewpoint, a different TX coil results in a different $k$, which will change the reflected impedance from the RX coil, and thus, affect $η_{SYS}$. However, $η_{SYS}$ is still increased. Thus, it can be concluded that $η$ plays an important role in determining $η_{SYS}$, as mentioned in Section I.

Fig. 15(a) shows the measured $η_{SYS}$ using the digital TX coil. It has a maximum value of 48% at (0 mm, 0 mm). In Fig. 15(b), $η_{SYS}$ is shown to be improved under the variation of distance and lateral misalignment compared with that for the conventional TX coil (TX$_1$). The maximum absolute improvement of 7% is at (0 mm, 0 mm), which is the most common position of the RX coil.

VI. CONCLUSION

A WPT system utilizing a digital TX coil topology that is robust against the variation of distance and lateral misalignment is proposed. Its radius can be programmed to its optimal value for the maximum coil-to-coil efficiency for each position of the RX coil. A practical design methodology is proposed, and it is concluded that the digital TX coil consisting of two subcoils is an effective design and that the performance is not significantly improved by adding more subcoils. The optimal radius ratio of these two subcoils is 0.54. In the fabricated WPT prototype, the system efficiency is improved by the digital TX coil and reaches a maximum value of 48%. Compared with using a conventional TX coil with a constant radius, the system efficiency shows an absolute improvement of up to 7%.

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